# **GigaDevice Semiconductor Inc.**

# **Device Limitations of GD32H73x/H75x**

# **Errata Sheet**

**Revision 1.6** 

(Jan. 2025)



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## 1. Introduction

This document applies to GD32H73x/H75x product series, as shown in <u>Table 1-1. Applicable</u> <u>products</u>. It offers technical guidance for using GD32MCU and provides workaround to current device limitations.

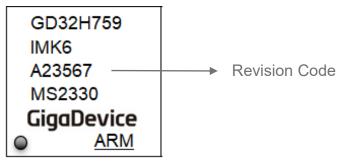
Table 1-1.	Applicable	products
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Type Part Numbers	
MCU	GD32H737xx series
MCU	GD32H757xx series
MCU	GD32H759xx series

## 1.1. Revision identification

The device revision can be identified according to the mark on the top of the package. The 1st code on Line 3 of the mark is the product revision code, as shown in *Figure 1-1. Device revision code of GD32H73x/H75x*.

Figure 1-1. Device revision code of GD32H73x/H75x



## 1.2. Summary of device limitations

The device limitations of GD32H73X/H75X are shown in <u>*Table 1-2. Device limitations*</u>, please refer to Section 2 for more details.

		Workaround	
Module	Limitations		Rev.
			Code C
	SysTick is clocked with the system clock (CK_SYS) divided	Y	
SYSTEM	by 2 when using external clock source	T	
	ECC error due to illegal address access	Y	
FMC	Protection-removed mass erase function cannot be disabled	Ν	
PMU	Chip damage risk in SMPS mode of the LQFP package	Y	



## Device Limitations of GD32H73x/H75x

Code ACode ACodeVDDSMPS cannot be connected to a low level when not using SMPSY-SMPSY-PXY pin connects to PXY_C pin in standby modeY-After VDD and VDDA are powered off, if voltage continues to be injected into GPIO (except for PA9 / PA10 / PB12 / PB13), it may lead to an overcurrent risk in the chip's GPIOYTRNGLFSR algorithm failureY-BGSWD and JTAG debug function failure when using low power debug functionN-SWD connection fails when PA15 is low levelY-ADCThe analog watchdog threshold comparison fails when used simultaneously with oversampling in a 14-bit ADCY-RTCWhen using RTC reference clock detection function, PB13/PB15 will be configured as input floating modeY-Voltage or temperature changes in the backup domain cannot trigger the tamper functionN-	ev. de C   Y  
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OSPI When OSPI sends only data segments, the first clock is lost Y	Y
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	Y
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The CAN peripheral cannot function without using HXTAL Y -	
CAN RAM area may be tampered in receiving mailbox	
processing	 Y



## Device Limitations of GD32H73x/H75x

	Limitations		Workaround	
Module			Rev.	
		Code A	Code C	
	After Bus off recovery, transmit error count is not cleared automatically	Y	Y	
	The mailbox data is not read in time may result in incorrect data reading for the current and next frames	Y	Y	
	When the CAN operating clock frequency is less than CK_APB2 and an error occurs in DLC segment, which will lead to receiving an incorrect frame ID	Y	Y	
USBHS	USBHS OTG sensitivity problem	Y		

#### Note:

Y = Limitation present, workaround available

N = Limitation present, no workaround available

'--' = Limitation fixed



## 2. Descriptions of device limitations

## 2.1. SYSTEM

#### 2.1.1. SysTick is clocked with the system clock (CK\_SYS) divided by 2 when

#### using external clock source

#### **Description & impact**

When SysTick uses external clock source, the SysTick clock is CK\_SYS / 2 instead of CK\_SYS / 8.

#### Workarounds

Use CK\_SYS / 2 to calculate the SysTick time when using external clock source.

#### 2.1.2. ECC error due to illegal address access

#### **Description & impact**

When illegal address is accessed, CPU will generate ECC error.

#### Workarounds

Use one of the following solutions:

- 1) Avoid accessing illegal addresses.
- 2) Implement software processes to handle ECC errors after accessing an illegal address.

## 2.2. FMC

#### 2.2.1. Protection-removed mass erase function cannot be disabled

#### **Description & impact**

The mass erase operation will only perform the protection-removed function when the following conditions are all satisfied in the protection-removed mass erase sequence:

1. If a secure user area exists, set the SCR\_EREN bit in the FMC\_SCRADDR\_MD register and ensure that the secure user area end address is less than the secure user area start address by programming SCR\_AREA\_END < SCR\_AREA\_START to the FMC\_SCRADDR\_EFT register.

2. Set all WP (Write Protection) bits in the FMC\_WP\_MDF register if any erase/program protected sector exists.



3. Unlock the FMC\_CTL register if necessary.

Otherwise, the protection-removed mass erase function cannot be disabled. Information regarding the protection-removed mass erase can be found in Chapter 3.3.5 of the user manual.

#### Workarounds

Not available.

### 2.3. PMU

#### 2.3.1. Chip damage risk in SMPS mode of the LQFP package

#### **Description & impact**

In the LQFP package, there is a risk of chip damage due to leakage when the junction temperature (Tj) exceeds 125°C in SMPS mode.

**Note:** This limitation applies to LQFP176 package.

#### Workarounds

Avoid using SMPS mode in the LQFP package.

#### 2.3.2. VDDSMPS cannot be connected to a low level when not using SMPS

#### **Description & impact**

VDDSMPS cannot be connected to a low level when not using SMPS.

**Note:** This limitation applies to LQFP176 and BGA176 package.

#### Workarounds

Connect VDDSMPS pin to a high level or leave it floating.

## 2.4. GPIO

#### 2.4.1. PXY pin connects to PXY\_C pin in standby mode

#### **Description & impact**

When the MCU enters standby mode, the PXY pin will connect to the PXY\_C pin, which includes PA0 / PA0\_C, PA1 / PA1\_C, PC2 / PC2\_C, and PC3 / PC3\_C.

#### Workarounds

Evaluate the impact based on application scenarios, such as using PA0 as wakeup pin in



standby mode.

## 2.4.2. After VDD and VDDA are powered off, if voltage continues to be injected into GPIO (except for PA9 / PA10 / PB12 / PB13), it may lead to an overcurrent risk in the chip's GPIO

#### **Description & impact**

When the chip's VDD and VDDA are powered off, if voltage (Vin) continues to be injected externally into the GPIO (except for PA9 / PA10 / PB12 / PB13), due to the ESD protection circuit of the GPIO, the externally injected voltage may leak to VDD, forming a voltage of Vin-0.7V. If Vin-0.7V is near the POR (1.6V), it may satisfy the POR conditions for the chip. However, due to the limited overcurrent capacity of the GPIO, this may lead to repeated POR/PDR events in the system, resulting in unpredictable risks for the system.

#### Workarounds

In system design, an undervoltage reset chip should be externally connected between the chip's VDD and NRST to ensure that when the voltage leaked from GPIO to VDD is below the threshold voltage of the undervoltage reset chip, it can directly pull down NRST to avoid erroneous operations. For a specific solution, you can refer to the "AN225 GD32H7xx Power Bypass Mode User Guide".

## 2.5. TRNG

#### 2.5.1. LFSR algorithm failure

#### **Description & impact**

The LFSR (Linear Feedback Shift Register) algorithm for generating random numbers is not functioning.

#### Workarounds

Do not use LFSR; instead, use the NIST (National Institute of Standards and Technology) algorithm.

#### 2.6. DBG

# 2.6.1. SWD and JTAG debug function failure when using low power debug

function

**Description & impact** 



When using the low power debug function (set STB\_HOLD / DSLP\_HOLD / SLP\_HOLD bit), the debug function will fail.

#### Workarounds

Do not use low power debug function.

#### 2.6.2. SWD connection fails when PA15 is low level

#### **Description & impact**

After power-on, if the level of PA15 is low, the SWD connection will fail.

#### Workarounds

Use one of the following solutions:

- 1) Do not drive PA15 to a low level when using SWD debug.
- 2) Do not configure PA15 as an AF0 function.

### 2.7. ADC

# 2.7.1. The analog watchdog threshold comparison fails when used simultaneously with oversampling in a 14-bit ADC

#### **Description & impact**

When the oversample function is enabled in a 14-bit ADC (ADC0/ADC1), the analog watchdog function fails because it does not compare the accumulated sum with the low threshold.

#### Workarounds

Do not use the analog watchdog function simultaneously with oversampling in a 14-bit ADC.

## 2.8. RTC

#### 2.8.1. When using RTC reference clock detection function, PB13/PB15 will be

#### configured as input floating mode

#### **Description & impact**

When using the RTC reference clock detection function (by setting the REFEN bit in the RTC\_CTL register), PB13/PB15 pins will be set to input floating mode.

#### Workarounds



Use one of the following solutions:

- 1) Do not use the RTC reference clock detection function.
- 2) When using the RTC reference clock detection function, set PB13/PB15 to input floating mode.

#### 2.8.2. Voltage or temperature changes in the backup domain cannot trigger the

#### tamper function

#### **Description & impact**

When the backup domain supply is VBAT due to VDD power down, voltage and temperature changes cannot trigger the tamper function.

#### Workarounds

Not available.

#### 2.9. TIMER

#### 2.9.1. TIMER interrupt is at risk of triggering by mistake

#### **Description & impact**

When the TIMER interrupt is enabled and the MCU operates at a high frequency, there is a risk that the corresponding TIMER interrupt flag may not be cleared in time due to the high code execution speed and the time required to clear the interrupt flag, leading to the risk of repeatedly entering the TIMER interrupt.

#### Workarounds

Clear the corresponding TIMER interrupt flag at the beginning of the TIMER interrupt handling function, and maintain more than 20 instruction cycles before exiting the interrupt.

## 2.10. USART

#### 2.10.1. When USART FIFO is enabled, the last byte of the frame cannot be

#### transmitted

#### **Description & impact**

When USART FIFO function is enabled, USART will not transmit the last byte of a frame. For example, when transmitting ten characters '0123456789', the character '9' will not be transmitted.



#### Workarounds

Fill an invalid byte at the end of a transmit frame, such as '\n' in '0123456789\n', and to ensure proper transmission, the following operation needs to be executed before every data transmit.

- 1) Disable fifo
- 2) Disable usart
- 3) Transmit data flush request (set TXFCMD bit)
- 4) Enable fifo
- 5) Enable usart

#### 2.10.2. When USART FIFO is enabled, DMA cannot transmit data

#### **Description & impact**

When both USART FIFO and USART DMA functions are enabled, DMA can transmit data only once.

#### Workarounds

Use one of the following solutions:

- 1) Use USART DMA only; do not use USART FIFO.
- 2) Use USART FIFO only; do not use USART DMA.

#### 2.10.3. Data sample error occurs in LIN mode

#### **Description & impact**

When USART is in LIN mode as a receiver, data sample errors occur because the autobaud rate detection function is enabled before receiving the break frame.

#### Workarounds

- 1) Disable the autobaud rate detection function before receiving the break frame.
- Enable the autobaud rate detection function after the LIN break detected flag (LBDF) is set.

#### 2.10.4. In mute mode, the parity error caused by non-wake frames will set PERR

#### bit

#### **Description & impact**

In mute mode, a parity error caused by a non-wake frame will result in a parity error (the PERR bit in the USART\_STAT register is set) when no parity error is found in the wake frame.

#### Workarounds

The software ignores the parity error flag generated in this case.



## 2.11. OSPI

#### 2.11.1. Interrupt and DMA functions are invalid when OSPI is used in indirect

#### write mode

#### **Description & impact**

When using OSPI indirect write mode, interrupt and DMA functions are invalid because the FIFO threshold flag (FT) cannot be set.

#### Workarounds

Use polling mode instead of indirect write mode.

#### 2.11.2. When OSPI sends only data segments, the first clock is lost

#### Description & impact

When OSPI sends only data segments, the first clock is lost, which results in the first data loss.

#### Workarounds

Send the first data as a command.

#### 2.11.3. When OSPI running clock is greater than 100MHz, read external memory

#### status flag abnormal in status polling mode

#### Description & impact

When the OSPI running clock is greater than 100MHz, the external memory may not be ready due to the hardware continuous polling interval is not enough, then OSPI will perform subsequent operations, which results in an exception.

#### Workarounds

Add a hardware delay (such as 20ms delay) before each poll of memory state.

## 2.12. EXMC

#### 2.12.1. Auto refresh function of SDRAM controller is influenced by other EXMC

#### controller

**Description & impact** 



Auto refresh function of SDRAM controller is influenced by other EXMC controller. When SDRAM controller execute auto refresh command, if the SDRAM bank is active, the precharge command shall be generated, which need EXMC\_A10 port be 1. At that time, EXMC\_A10 port is used in other EXMC controller, then the SDRAM auto refresh command execute abnormally which lead SDRAM data error.

#### Workarounds

Step1: enable EXMC SDRAM controller works simultaneously with other controllers after EXMC initialization.

/\* code example \*/

REG32(EXMC + 0x184U) = 0x9EF02310U; EXMC\_SDRSCTL |= BIT(9);

#### Step2:

Method 1: When SDRAM controller selects the BANK address of the operation, the pin output does not use the AF function and accesses the corresponding BANK directly through GPIO to drive the BANK address.

Method 2: Before EXMC operates on NAND FLASH, the global precharge instruction of SDRAM is added, so that the self-refresh operation of SDRAM does not need to rely on the original precharge instruction, so even if the self-refresh and nand occur at the same time, there is no error.

/\* code example \*/ REG32(0xA0000150U) = (uint32\_t)0x00000012U; while(0x000000000 != (REG32(0xA0000158U) & 0x00000020)) {

#### 2.12.2. The bus may stuck during SDRAM access

#### **Description & impact**

When accessing SDRAM, if the SDRAM data bit width is 32 bits, the bus sends two 8-bit or two 16-bit accesses, and then sends a 64-bit access, if the 64-bit access data happens to be composed of the previous two 8-bit or 16-bit accesses, the bus may stuck.

#### Workarounds

Use one of the following solutions:

- 1) Disable burst access to SDRAM (clear BRSTRD bit of EXMC\_SDCTL0/1 register)
- 2) Enable the CPU cache function

#### 2.12.3. Does not support unaligned address access

#### **Description & impact**

The bus does not support unaligned address access to SDRAM.



#### Workarounds

Enable the cache function of the CPU before accessing SDRAM.

## 2.13. LPDTS

# 2.13.1. The temperature sensor ready flag cannot be cleared after disabling LPDTS

#### **Description & impact**

The temperature sensor ready flag (TSRF) cannot be cleared after disabling LPDTS (Low power digital temperature sensor).

#### Workarounds

Reset the LPDTS peripheral before enabling LPDTS.

## 2.14. CAN

#### 2.14.1. The transmit mailbox may experience transmission failures when exiting

#### inactive mode

#### **Description & impact**

If a mailbox is configured as the Tx mailbox in inactive mode, it may not be sent due to the absence of an internal trigger after exiting inactive mode.

#### Workarounds

Use one of the following solutions:

- 1) Another node sends a frame.
- 2) Software writes to an invalid mailbox.

#### 2.14.2. CAN transmit node performs unwanted automatic calibration

#### **Description & impact**

When the delay (from TX to RX readback + 2 \* CK\_CAN) exceeds a Tq time, CAN will automatically perform calibration, which results in transmitted dominant level extension and errors.

#### Workarounds

Use the GD32 MCU CAN transmission software solution, referring to "AN222 GD32A5x3



software evasion of CAN bit time problem".

#### 2.14.3. The CAN peripheral cannot function without using HXTAL

#### **Description & impact**

The CAN peripheral cannot work when the HXTAL clock is not enabled.

#### Workarounds

Turn on the HXTAL clock and wait for HXTAL clock stabilization before configuring the CAN peripheral clock source, then you can shut down the HXTAL clock as needed.

#### 2.14.4. CAN RAM area may be tampered in receiving mailbox processing

#### **Description & impact**

If the global mailbox unlocking operation is not performed in the receiving mailbox processing routine (due to incorrect operation in the software), there is a certain probability that the CAN RAM area will be tampered, which will cause data transmission and reception exceptions.

#### Workarounds

Wait for the sending completion flag in CAN\_STAT register to be set instead of judging by the CODE segment value of the sent mailbox before every data transmission. The reference code is as follow:

```
Flagstatus can_tx_status = RESET;
{
    if((RESET == can_tx_state) || (SET == can_flag_get(CAN1, CAN_FLAG_MB1))){
        can_tx_state = SET;
        can_flag_clear(CAN1, CAN_FLAG_MB1);
        /* transmit message */
        can_mailbox_config(CAN1, 1, &transmit_message);
        /* user code */
    }
}
```

#### 2.14.5. After Bus off recovery, transmit error count is not cleared automatically

#### **Description & impact**

After Bus off recovery, transmit error count (TECNT) is not cleared automatically by hardware.

#### Workarounds

After Bus off recovery, using software method to clear the transmit error count (TECNT). Taking CAN1 as an example, the reference code is as follow.

{



```
/* bus off recovery flag is set */
if(RESET != can_flag_get(CAN1, CAN_FLAG_BUSOFF_RECOVERY))
{
    /* enter inactive mode */
    can_operation_mode_enter(CAN1, CAN_INACTIVE_MODE);
    /* clear transmit error count */
    CAN_ERR0(CAN1) &= ~(CAN_ERR0_TECNT);
    /* enter normal mode */
    can_operation_mode_enter(CAN1, CAN_NORMAL_MODE);
    can_flag_clear(CAN1, CAN_FLAG_BUSOFF_RECOVERY);
}
```

#### 2.14.6. The mailbox data is not read in time may result in incorrect data reading

#### for the current and next frames

#### **Description & impact**

When handling mailbox receive, if a new CAN frame (the next frame) is moved into the receive mailbox while reading this receive mailbox data (the current frame), it may lead to incorrect reading of the current frame and the next frame data.

Note: Only the current frame and the next frame are affected.

#### Workarounds

Use one of the following solutions:

- 1) Use mailbox reception interrupt and configure it to highest priority. When a receive mailbox interrupt occurs, promptly read and process the mailbox data (before the end of the next frame).
- 2) Use CAN FIFO reception instead of mailbox reception.
- 3) Enable the mailbox queue by setting the RPFQEN bit and set the mailbox reception interrupt to the highest priority.

#### 2.14.7. When the CAN operating clock frequency is less than CK\_APB2 and an

error occurs in DLC segment, which will lead to receiving an incorrect

#### frame ID

#### **Description & impact**

When the CAN operating clock frequency is less than CK\_APB2, if external interference on the CAN bus causes an error frame to be sent due to an error detected in the DLC segment while receiving a frame, this will result in the subsequent frame receiving the error frame ID



(even if this error frame ID is filtered by the CAN filter).

#### Workarounds

{

}

Use one of the following solutions:

1) The software configures CAN clock source as CK\_APB2. Taking CAN1 as an example, the reference code is as follow:

/\* configure the CAN1 clock source as CK\_APB2 \*/ rcu\_can\_clock\_config(IDX\_CAN1, RCU\_CANSRC\_APB2);

- 2) Software checks the frame ID (applicable when the CAN operating clock frequency is less than CK\_APB2). When the CAN mailbox receives a non-target frame ID and an error occurs, the software needs to reconfigure the CAN reception mailbox parameters. The specific configuration steps are as follows:
  - a) Enter inactive mode
  - b) Reconfigure the reception mailbox parameters
  - c) Enter normal mode

## 2.15. USBHS

#### 2.15.1. USBHS OTG sensitivity problem

#### **Description & impact**

USBHS OTG can function normally but fails to pass the sensitivity test.

#### Workarounds

Configure the USBHS internal corresponding reserved register to avoid the issue.



## 3. Revision history

#### Table 3-1. Revision history

Revision No.	Description	Date
1.0	Initial Release	Sep.12 2023
1.1	Update descriptions of contents	Sep.26 2023
	1. Add limitations of Rev. Code C.	
1.2	2. Add USART / OSPI / EXMC periphera	ls Apr.20 2024
	limitations.	
	1. Update description and workarounds	of
	EXMC, refer to Auto refresh function	<u>of</u>
	SDRAM controller is influenced by othe	<u>er</u>
	EXMC controller.	
	2. Add limitations, refer to TIMER is at risk	<u>of</u>
1.3	triggering an interrupt by mistake.	Aug 5 2024
1.5	3. Add limitations, refer to CAN RAM area ma	Aug.5 2024
	be tampered in receiving mailbo	<u>x</u>
	processing.	
	4. Update workarounds of CAN, refer to As	<u>a</u>
	transmitting node, CAN execute	<u>es</u>
	unexpected self-calibration function.	
	1. Update the description of PMU limitatio	n,
	refer to <u>Chip damage risk in SMPS mod</u>	<u>le</u>
	<u>of the LQFP package</u> and <u>VDDSMP</u>	<u>s</u>
1.4	cannot be connected to a low level whe	<u>n</u>
1.4	not using SMPS	Sep.1 2024
	2. Update the description of TIMER limitation	n,
	refer to <u>TIMER interrupt is at risk</u> o	<u>of</u>
	triggering by mistake	
	1. Add limitations of CAN, refer to After Bu	<u>is</u>
	off recovery, transmit error count is no	<u>ot</u>
	cleared automatically	
	2. Add limitations of CAN, refer to <i>The mailbo</i>	<u>x</u>
	<u>data is not read in time may result</u> i	i <u>n</u>
1 5	incorrect data reading for the current an	<u>Id</u> Dog 15 2024
1.5	<u>next frames</u>	Dec.15 2024
	3. Add limitations of CAN, refer to When the	<u>ne</u>
	CAN operating clock frequency is les	<u>is</u>
	than CK_APB2 and an error occurs	in l
	DLC segment, which will lead a	to
	receiving an incorrect frame ID	
1.6	Add limitations of GPIO, refer to <u>After VDD a</u>	<u>nd</u> Jan.13 2025



## Device Limitations of GD32H73x/H75x

VDDA are powered off, if voltage continues to	
be injected into GPIO (except for PA9 / PA10 /	
PB12 / PB13), it may lead to an overcurrent risk	
in the chip's GPIO	



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